

ST223C..C SERIES

INVERTER GRADE THYRISTORS

Hockey Puk Version

Features

- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)
- All diffused design
- Center amplifying gate
- Guaranteed high dV/dt
- Guaranteed high dI/dt
- High surge current capability
- Low thermal impedance
- High speed performance

390A

Typical Applications

- Inverters
- Choppers
- Induction heating
- All types of force-commutated converters

case style TO-200AB (A-PUK)

Major Ratings and Characteristics

Parameters	ST223C..C	Units
$I_{T(AV)}$	390	A
@ T_{hs}	55	°C
$I_{T(RMS)}$	745	A
@ T_{hs}	25	°C
I_{TSM}	5850	A
@ 50Hz	5850	A
@ 60Hz	6130	A
I^2t	171	KA ² s
@ 50Hz	171	KA ² s
@ 60Hz	156	KA ² s
V_{DRM}/V_{RRM}	400 to 800	V
t_q range	10 to 30	μs
T_J	- 40 to 125	°C

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Bulletin I25174 rev. B 04/00

International
IR Rectifier

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , maximum repetitive peak voltage V	V_{RSM} , maximum non-repetitive peak voltage V	I_{DRM}/I_{RRM} max. @ $T_J = T_{J\max}$. mA
ST223C..C	04	400	500	40
	08	800	900	

Current Carrying Capability

Frequency				Units
50Hz	930	800	1430	A
400Hz	910	770	1490	
1000Hz	780	650	1430	
2500Hz	490	400	1070	
Recovery voltage V_r	50	50	50	V
Voltage before turn-on V_d	V_{DRM}	V_{DRM}	V_{DRM}	
Rise of on-state current dI/dt	50	50	-	A/ μ s
Heatsink temperature	40	55	40	°C
Equivalent values for RC circuit	47Ω / 0.22μF	47Ω / 0.22μF	47Ω / 0.22μF	

On-state Conduction

Parameter	ST223C..C	Units	Conditions			
$I_{T(AV)}$	390 (150)	A	180° conduction, half sine wave double side (single side) cooled			
	55 (85)	°C				
$I_{T(RMS)}$	745		DC @ 25°C heatsink temperature double side cooled			
I_{TSM}	5850	A	t = 10ms	No voltage reapplied	Sinusoidal half wave, Initial $T_J = T_{J\max}$	
	6130			t = 8.3ms		
	4920			t = 10ms	100% V_{RRM}	
	5150			t = 8.3ms	reapplied	
I^2t	171	KA ² s	t = 10ms	No voltage reapplied	Initial $T_J = T_{J\max}$	
	156		t = 8.3ms			
	121		t = 10ms	100% V_{RRM}		
	110		t = 8.3ms	reapplied		
$I^2\sqrt{t}$	1710	KA ² /s	t = 0.1 to 10ms, no voltage reapplied			

On-state Conduction

Parameter	ST223C..C	Units	Conditions	
V_{TM}	Max. peak on-state voltage	1.58	V	$I_{TM} = 600A, T_J = T_J \text{ max}, t_p = 10\text{ms sine wave pulse}$
$V_{T(TO)1}$	Low level value of threshold voltage	1.05		$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}, T_J = T_J \text{ max.})$
$V_{T(TO)2}$	High level value of threshold voltage	1.09		$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
r_{t1}	Low level value of forward slope resistance	0.88	$\text{m}\Omega$	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}, T_J = T_J \text{ max.})$
r_{t2}	High level value of forward slope resistance	0.82		$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
I_H	Maximum holding current	600	mA	$T_J = 25^\circ\text{C}, I_T > 30A$
I_L	Typical latching current	1000		$T_J = 25^\circ\text{C}, V_A = 12V, R_a = 6\Omega, I_G = 1A$

Switching

Parameter	ST223C..C	Units	Conditions
di/dt	Max. non-repetitive rate of rise of turned-on current	$A/\mu\text{s}$	$T_J = T_J \text{ max}, V_{DRM} = \text{rated } V_{DRM}$ $I_{TM} = 2 \times di/dt$
t_d	Typical delay time		$T_J = 25^\circ\text{C}, V_{DM} = \text{rated } V_{DRM}, I_{TM} = 50A \text{ DC}, t_p = 1\mu\text{s}$ Resistive load, Gate pulse: 10V, 5Ω source
t_q	Max. turn-off time	Min	$T_J = T_J \text{ max}, I_{TM} = 300A, \text{commutating } di/dt = 20A/\mu\text{s}$
		Max	$V_R = 50V, t_p = 500\mu\text{s}, dv/dt: \text{see table in device code}$

Blocking

Parameter	ST223C..C	Units	Conditions
dv/dt	Maximum critical rate of rise of off-state voltage	$V/\mu\text{s}$	$T_J = T_J \text{ max, linear to } 80\% V_{DRM}$, higher value available on request
I_{RRM}	Max. peak reverse and off-state leakage current	mA	$T_J = T_J \text{ max, rated } V_{DRM}/V_{RRM} \text{ applied}$

Triggering

Parameter	ST223C..C	Units	Conditions
P_{GM}	Maximum peak gate power	W	$T_J = T_J \text{ max, } f = 50\text{Hz, d\% = 50}$
$P_{G(AV)}$	Maximum average gate power		
I_{GM}	Max. peak positive gate current	A	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
$+V_{GM}$	Maximum peak positive gate voltage		
$-V_{GM}$	Maximum peak negative gate voltage	V	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
I_{GT}	Max. DC gate current required to trigger	mA	$T_J = 25^\circ\text{C, } V_A = 12V, R_a = 6\Omega$
V_{GT}	Max. DC gate voltage required to trigger		
I_{GD}	Max. DC gate current not to trigger	mA	$T_J = T_J \text{ max, rated } V_{DRM} \text{ applied}$
V_{GD}	Max. DC gate voltage not to trigger		

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Thermal and Mechanical Specification

Parameter	ST223C..C	Units	Conditions
T_J	Max. operating temperature range	-40 to 125	°C
T_{sg}	Max. storage temperature range	-40 to 150	
R_{thJ-hs}	Max. thermal resistance, junction to heatsink	0.17 0.08	K/W
R_{thC-hs}	Max. thermal resistance, case to heatsink	0.033 0.017	K/W
F	Mounting force, ± 10%	4900 (500)	N (Kg)
wt	Approximate weight	50	g
Case style	TO - 200AB (A-PUK)	See Outline Table	

ΔR_{thJ-hs} Conduction

(The following table shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction		Rectangular conduction		Units	Conditions
	Single Side	Double Side	Single Side	Double Side		
180°	0.015	0.017	0.011	0.011	K/W	$T_J = T_{J\ max.}$
120°	0.019	0.019	0.019	0.019		
90°	0.024	0.024	0.026	0.026		
60°	0.035	0.035	0.036	0.037		
30°	0.060	0.060	0.060	0.061		

Ordering Information Table

Device Code	ST	22	3	C	08	C	H	K	1	1	2	3	4	5	6	7	8	9	10
1	1	2	3	4	5	6	7	8	9	10									
2																			
3																			
4																			
5																			
6																			
7																			
8																			
9																			
10																			

1 - Thyristor
2 - Essential part number
3 - 3 = Fast turn off
4 - C = Ceramic Puk
5 - Voltage code: Code x 100 = V_{RRM} (See Voltage Rating Table)
6 - C = Puk Case TO-200AB (A-PUK)
7 - Reapplied dv/dt code (for t_q test condition)
8 - t_q code _____
9 - 0 = Eyelet term. (Gate and Aux. Cathode Unsoldered Leads)
 1 = Fast-on term. (Gate and Aux. Cathode Unsoldered Leads)
 2 = Eyelet term. (Gate and Aux. Cathode Soldered Leads)
 3 = Fast-on term. (Gate and Aux. Cathode Soldered Leads)
10 - Critical dv/dt:
 None = 500V/μsec (Standard value)
 L = 1000V/μsec (Special selection)

dv/dt - t_q combinations available						
dv/dt (V/μs)	20	50	100	200	400	
10	CN	DN	EN	FN *	--	
12	CM	DM	EM	FM	--	
15	CL	DL	EL	FL *	HL	
18	CP	DP	EP	FP	HP	
20	CK	DK	EK	FK	HK	
25	--	--	--	--	HJ	
30	--	--	--	--	HH	

*Standard part number.
All other types available only on request.

Outline Table

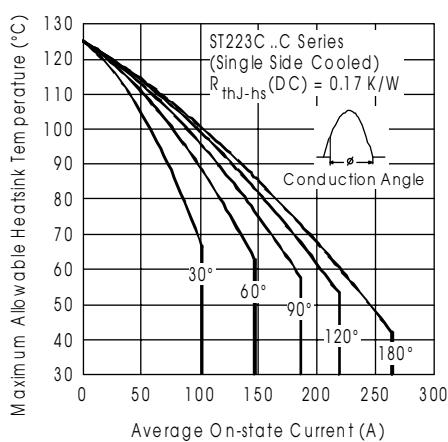
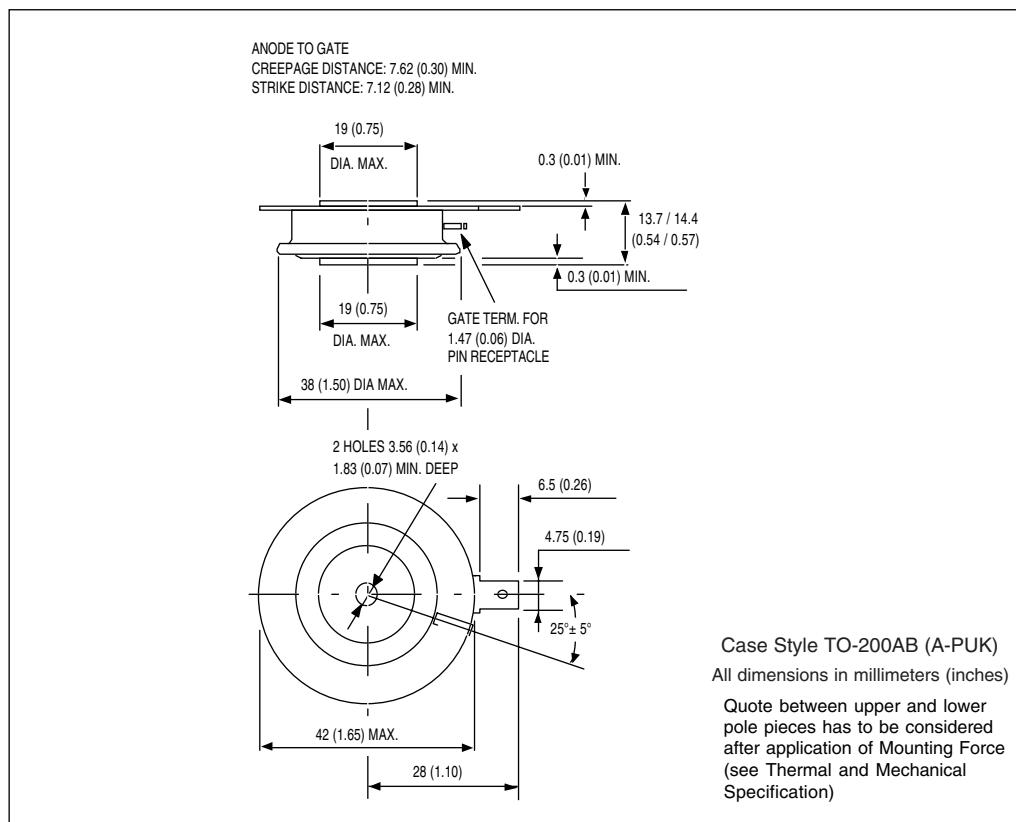


Fig. 1 - Current Ratings Characteristics

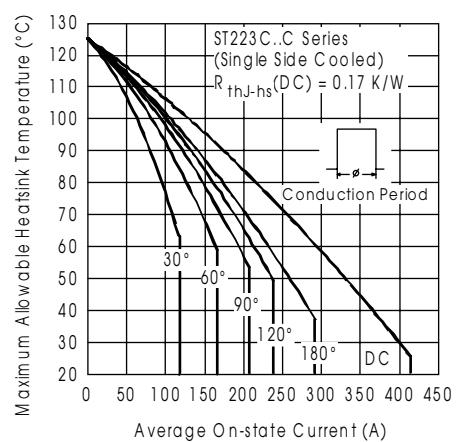


Fig. 2 - Current Ratings Characteristics

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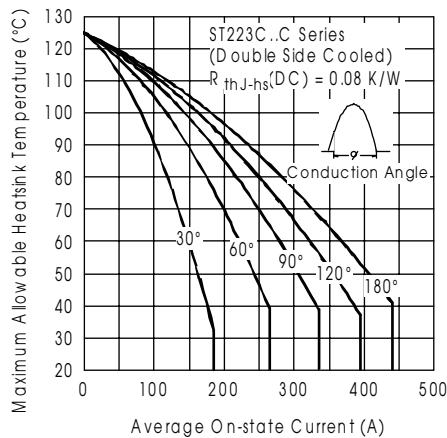


Fig. 3 - Current Ratings Characteristics

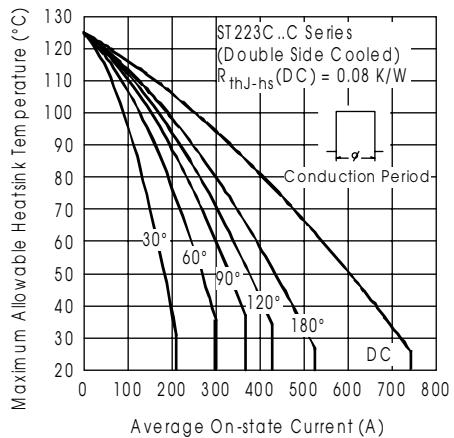


Fig. 4 - Current Ratings Characteristics

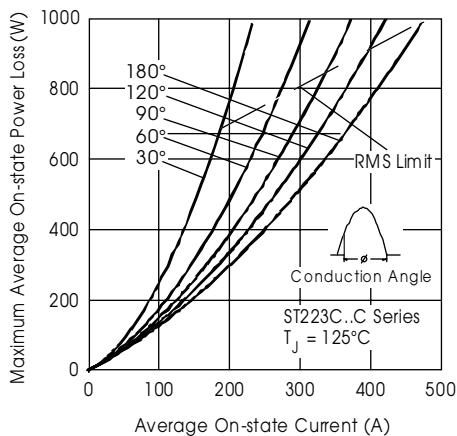


Fig. 5 - On-state Power Loss Characteristics

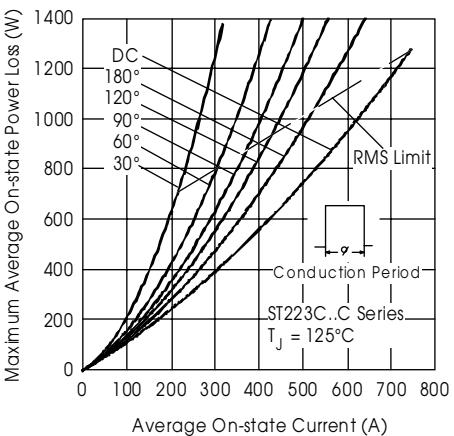


Fig. 6 - On-state Power Loss Characteristics

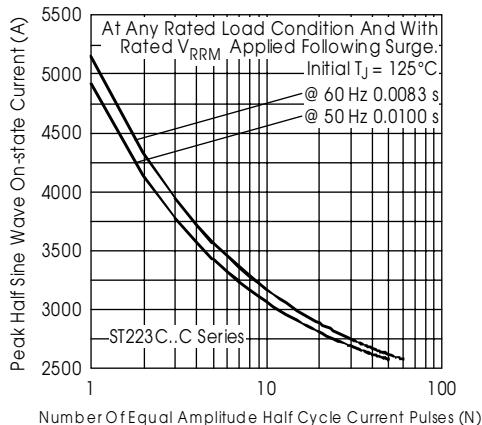


Fig. 7 - Maximum Non-repetitive Surge Current
Single and Double Side Cooled

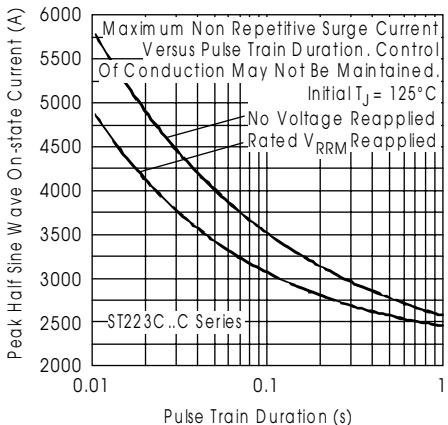


Fig. 8 - Maximum Non-repetitive Surge Current
Single and Double Side Cooled

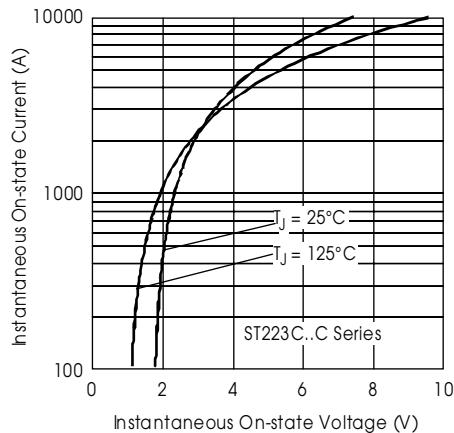


Fig. 9 - On-state Voltage Drop Characteristics

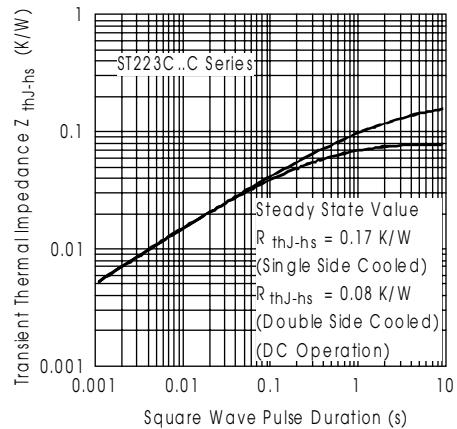


Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristics

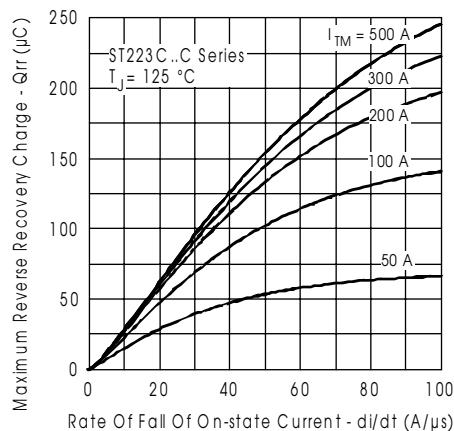


Fig. 11 - Reverse Recovered Charge Characteristics

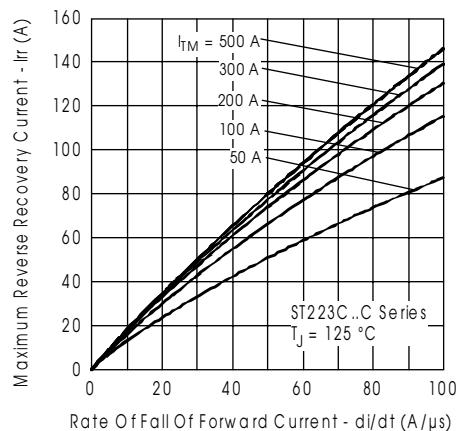


Fig. 12 - Reverse Recovery Current Characteristics

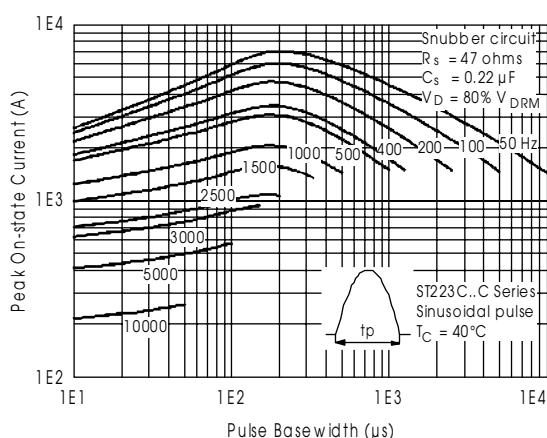
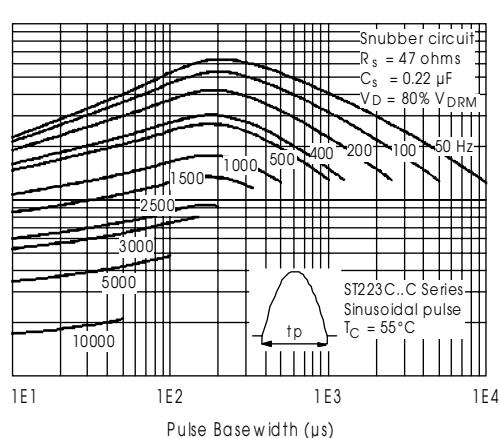


Fig. 13 - Frequency Characteristics



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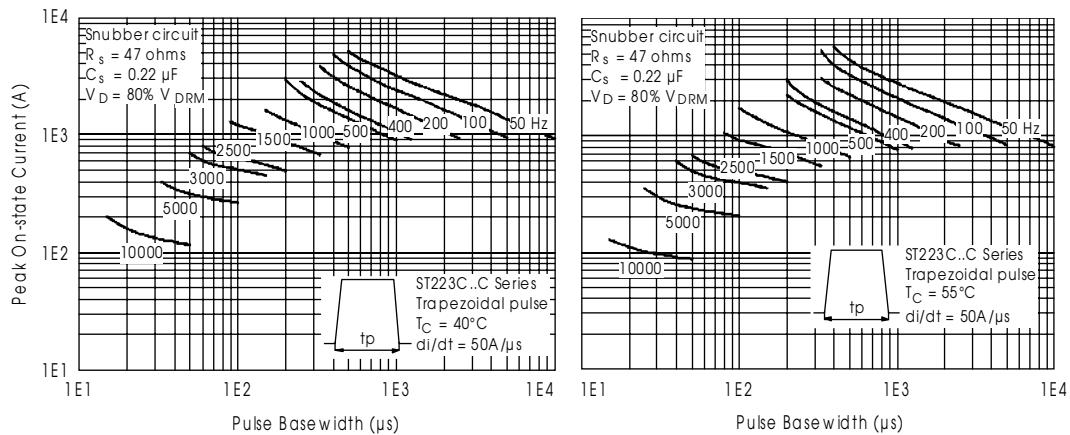


Fig. 14 - Frequency Characteristics

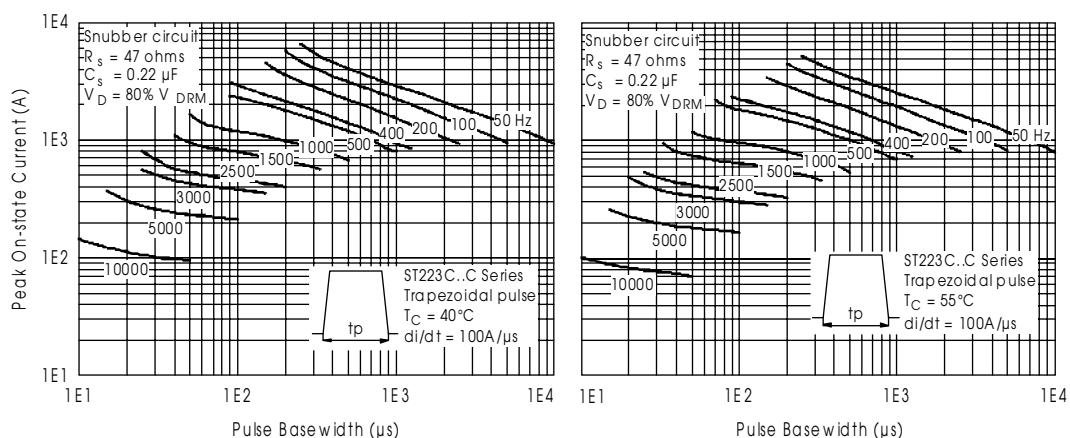


Fig. 15 - Frequency Characteristics

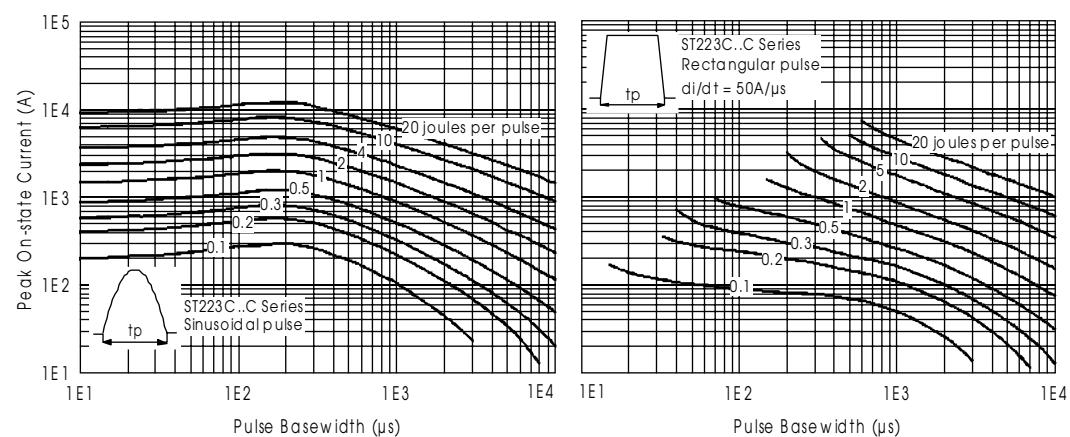


Fig. 16 - Maximum On-state Energy Power Loss Characteristics

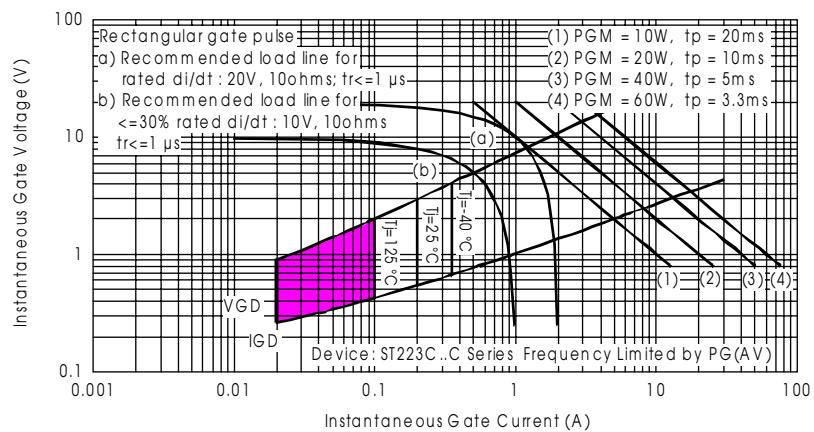


Fig. 17 - Gate Characteristics